PALM INTRANET

Day : Thursday
Date: 7/1/2004
Time: 14:29:55

Inventor Name Search Result

Your Search was:

Last Name = DUVALL
First Name = JAMES

Application#	Patent#	Status	Date Filed	Title	Inventor Name 12
60247986	Not Issued	159	11/14/2000	PRESSURE SENSITIVE FOOD GRADE WRAP FILM	DUVALL, JAMES H.
60220196	Not Issued	159	07/24/2000	PRESSURE SENSITIVE FOOD GRADE WRAP FILM	DUVALL, JAMES H.
60142751	Not Issued	159	07/08/1999	PHASE CHANGE THERMAL INTERFACE MATERIAL	DUVALL , JAMES
60078896	Not Issued	159	03/20/1998	ACCORDION AND/OR STRETCH CHAIR, LOVE SEAT, AND SOFA (COUCH)	DUVALL , JAMES ERIC
60057259	Not Issued	159	08/29/1997	PHASE CHANGE THERMAL INTERFACE MATERIAL	DUVALL , JAMES
60024940	Not Issued	159	08/30/1996	PHASE CHANGE THERMAL INTERFACE MATERIAL	DUVALL , JAMES
10761558	Not Issued	030	01/21/2004	METHOD OF FORMING A PHASE CHANGE THERMAL INTERFACE MATERIAL	DUVALL, JAMES H.
10405885	Not Issued	030	04/03/2003	PRESSURE SENSITIVE FOOD GRADE WRAP FILM AND PROCESS FOR MANUFACTURING SUCH A FILM	DUVALL, JAMES H.
10123324	6764759	150	04/16/2002	METHOD OF FORMING A PHASE CHANGE THERMAL INTERFACE	DUVALL, JAMES H.
09907991	Not Issued	041	07/18/2001	PRESSURE-SENSITIVE FOOD GRADE WRAP FILM AND PROCESS FOR MANUFACTURING SUCH A FILM	DUVALL, JAMES H.
09482590	6391442	150	01/13/2000	PHASE CHANGE THERMAL INTERFACE MATERIAL	DUVALL, JAMES H.
08078507	5339710	150	06/21/1993	OFFSET LINE SOCKET	DUVALL , JAMES E.

Inventor Search Completed: No Records to Display.

Search Another: Inventor

Last Name	First Name
Duvall	James

Search

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FILE 'HOME' ENTERED AT 15:51:44 ON 01 JUL 2004

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COST IN U.S. DOLLARS                                    SINCE FILE      TOTAL
                                                           ENTRY    SESSION
FULL ESTIMATED COST                                         0.21       0.21

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FILE 'USPAT2' ENTERED AT 15:51:56 ON 01 JUL 2004
CA INDEXING COPYRIGHT (C) 2004 AMERICAN CHEMICAL SOCIETY (ACS)

=> s thermal interface material#
   4 FILES SEARCHED...
L1          692 THERMAL INTERFACE MATERIAL#

=> s l1 and melting point component#
L2            4 L1 AND MELTING POINT COMPONENT#

=> s l2 and thermally conductive filler#
L3            4 L2 AND THERMALLY CONDUCTIVE FILLER#

=> d l3 1-4

L3     ANSWER 1 OF 4  EUROPATFULL  COPYRIGHT  2004 WILA on STN

PATENT APPLICATION - PATENTANMELDUNG - DEMANDE DE BREVET

AN     1067164  EUROPATFULL  ED 20010121  EW 200102  FS OS
TIEN   Phase change thermal interface material.
TIDE   Phasenveraenderliches, thermisches Zwischenlagermaterial.
TIFR   Materiau d'interphase thermique a changement de phase.
IN     Duvall, James H., 9545 Green Valley Drive, Mentor, Ohio 44060, US;
       Bergeron, Steve, 213 Old Point Road, Milford, Connecticut 06460, US;
       Balian, Charles, 10 Ridgeview Circle, Guilford, Connecticut 06437, US;
       Rogove, Arthur H., 114 Southpond Road, South Glastonbury, Connecticut
       06073, US
PA     Saint-Gobain Performance Plastics Corporation, 150 Dey Road, Wayne, New
       Jersey 07470, US
SO     Wila-EPZ-2001-H02-T1a
DS     R AT; R BE; R CH; R CY; R DE; R DK; R ES; R FI; R FR; R GB; R GR; R IE;
       R IT; R LI; R LU; R MC; R NL; R PT; R SE; R AL; R LT; R LV; R MK; R RO;
       R SI
PIT    EPA1 EUROPAEISCHE PATENTANMELDUNG
PI     EP 1067164           A1 20010110
OD                             20010110
AI     EP 2000-305747          20000707
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PRAI US 1999-142751 19990708
US 2000-482590 20000113
IC ICM C09K005-06
ICS H01L023-373

GRANTED PATENT - ERTEILTES PATENT - BREVET DELIVRE

AN 1067164 EUROPATFULL UP 20040611 EW 200424 FS PS
TIEN Phase change **thermal interface material**.
TIDE Phasenveraenderliches, thermisches Zwischenlagermaterial.
TIFR Materiau d'interphase thermique a changement de phase.
IN Duvall, James H., 9545 Green Valley Drive, Mentor, Ohio 44060, US;
Bergerson, Steve, 213 Old Point Road, Milford, Connecticut 06460, US;
Balian, Charles, 10 Ridgeview Circle, Guilford, Connecticut 06437, US;
Rogove, Arthur H., 114 Southpond Road, South Glastonbury, Connecticut 06073, US
PA Saint-Gobain Performance Plastics Corporation, 150 Dey Road, Wayne, New Jersey 07470, US
SO Wila-EPS-2004-H24-T1
DS R DE; R FR; R GB; R NL
PIT EPB1 EUROPAEISCHE PATENTSCHRIFT
PI EP 1067164 B1 20040609
OD 20010110
AI EP 2000-305747 20000707
PRAI US 1999-142751 19990708
US 2000-482590 20000113
REP EP 813244 A WO 97-41599 A
WO 99-19909 A US 5679457 A
IC ICM C09K005-06
ICS H01L023-373

L3 ANSWER 2 OF 4 USPATFULL on STN
AN 2003:294051 USPATFULL
TI Conformal **thermal interface material** for electronic components
IN Bunyan, Michael H., Chelmsford, MA, UNITED STATES
Sorgo, Miksa de, Windham, NH, UNITED STATES
PI US 2003207064 A1 20031106
US 6054198 (GRANTED)
AI US 2003-414884 A1 20030416 (10)
US 1997-801047 19970214 (GRANTED)
RLI Continuation of Ser. No. US 2000-714680, filed on 16 Nov 2000, PENDING
PRAI US 1996-16488P 19960429 (60)
DT Utility
FS APPLICATION
LN.CNT 744
INCL INCLM: 428/040.500
INCLS: 428/041.800; 524/399.000; 156/247.000
NCL NCLM: 428/040.500
NCLS: 428/041.800; 524/399.000; 156/247.000
IC [7]
ICM: C09J001-00
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L3 ANSWER 3 OF 4 USPATFULL on STN
AN 2003:57261 USPATFULL
TI Method of forming a phase change thermal interface
IN Duvall, James H., Mentor, OH, UNITED STATES
Bergerson, Steve, Milford, CT, UNITED STATES
Balian, Charles, Guilford, CT, UNITED STATES
Rogove, Arthur H., South Glastonbury, CT, UNITED STATES
PI US 2003039825 A1 20030227
AI US 2002-123324 A1 20020416 (10)
RLI Division of Ser. No. US 2000-482590, filed on 13 Jan 2000, GRANTED, Pat.

No. US 6391442
PRAI US 1999-142751P 19990708 (60)
DT Utility
FS APPLICATION'
LN.CNT 922
INCL INCLM: 428/348.000
NCL NCLM: 428/348.000
IC [7]
ICM: B32B007-12
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L3 ANSWER 4 OF 4 USPATFULL on STN
AN 2002:115908 USPATFULL
TI Phase change **thermal interface material**
IN Duvall, James H., Mentor, CT, United States
Bergerson, Steve, Milford, CT, United States
Balian, Charles, Guilford, CT, United States
Rogove, Arthur H., South Glastonbury, CT, United States
PA Saint-Gobain Performance Plastics Corporation, Wayne, NJ, United States
(U.S. corporation)
PI US 6391442 B1 20020521
AI US 2000-482590 20000113 (9)
PRAI US 1999-142751P 19990708 (60)
DT Utility
FS GRANTED
LN.CNT 869
INCL INCLM: 428/348.000
INCLS: 428/349.000; 428/354.000; 428/355.000R; 428/402.000; 428/403.000;
428/407.000; 428/920.000; 427/221.000; 427/218.000
NCL NCLM: 428/348.000
NCLS: 427/218.000; 427/221.000; 428/349.000; 428/354.000; 428/355.000R;
428/402.000; 428/403.000; 428/407.000; 428/920.000
IC [7]
ICM: B32B007-12
EXF 428/348; 428/349; 428/355R; 428/402; 428/403; 428/407; 428/920; 428/354;
427/221; 427/218

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